

PC55U14 V0

Product Specification

Approval Sheet

PC55U14 V0

Product Specification

RoHS

| | |
|--------------------|---------------|
| Product | White SMD LED |
| Part Number | PC55U14 V0 |
| Issue Date | 2016/06/23 |



■ Feature

- ✓ White SMD LED (L x W x H) of 5.8 x 5.2 x 0.7 mm
- ✓ ANSI binning
- ✓ Dice Technology : InGaN
- ✓ Qualified according to JEDEC moisture sensitivity Level 3
- ✓ Environmental friendly ; RoHS compliance
- ✓ Packing : 500 pcs/reel

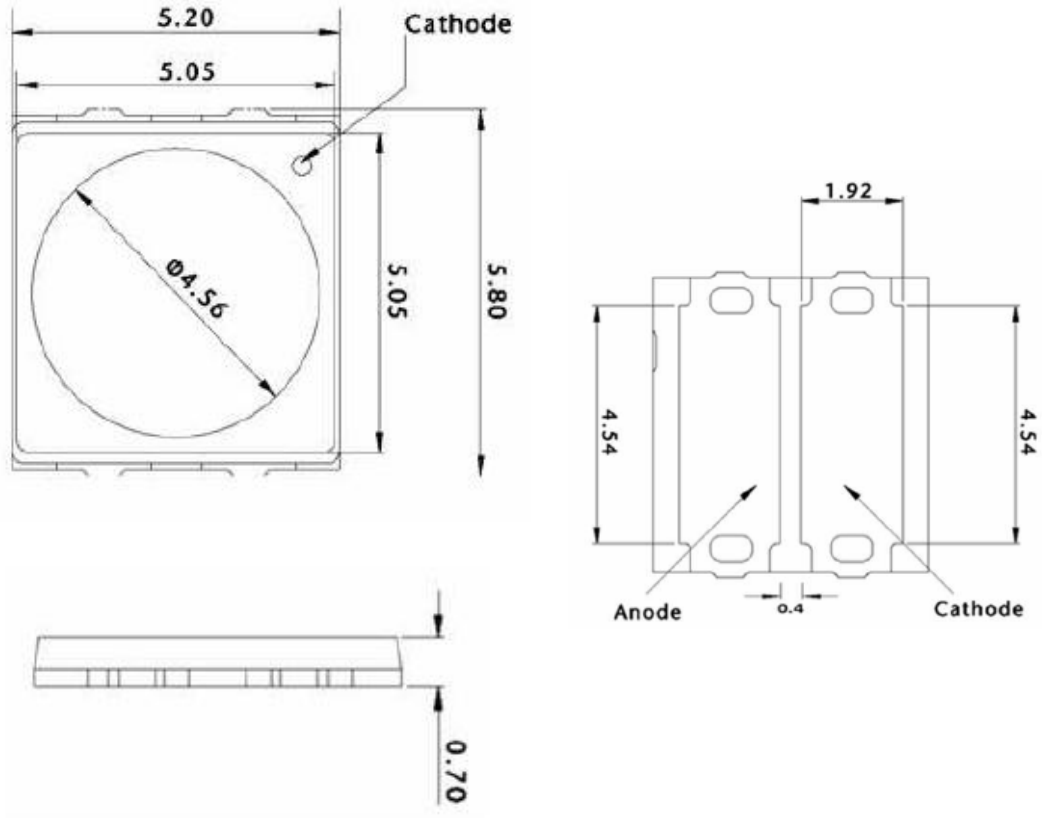
■ Applications

- ✓ MR16, GU10
- ✓ General lighting
- ✓ Outdoor lighting

Outline Dimension

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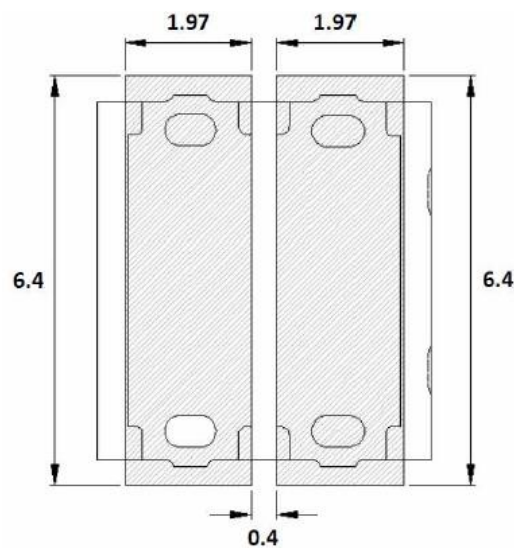
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Unit: mm,

Tolerance: ± 0.1 mm

■ Recommended Soldering Pad



Performance

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■ Electro-Optical Characteristics (Ta=25°C)

| Parameter | Symbol | Condition | Min. | Typ. | Max. | Unit |
|--------------------------------------|-----------------|-------------------------|------|------|------|------|
| Forward Voltage ⁽¹⁾ | V _F | I _F = 150 mA | 32.6 | 36.2 | 39.8 | V |
| Color Rendering Index ⁽²⁾ | R _a | | 90 | - | - | - |
| Color Rendering Index ⁽³⁾ | R ₉ | | 50 | | | |
| View Angle | θ | | - | 120 | - | deg |
| Thermal Resistance ⁽⁴⁾ | R _{th} | | - | 4 | - | °C/W |

(1) The Forward Voltage tolerance is ±0.1V

(2) The Color Rendering Index is measured at Ta=85°C and tolerance is ±2

(3) The R₉ is measured at Ta=85°C and tolerance is ±6.

(4) Thermal resistance is calculated from junction to solder

■ Luminous Flux (Ta=25°C)

| CCT | Condition | Rank | Typ. | Unit |
|-------------|-------------------------|-------|------|------|
| 2600K~3700K | I _F = 150 mA | GP,GQ | 600 | lm |
| 3700K~4200K | | GQ,GR | 635 | |

* The luminous flux tolerance is ± 7%

■ Absolute Maximum Ratings

| Parameter | Symbol | value | Unit |
|--------------------------------------|------------------|------------------|------|
| DC Forward Current ⁽¹⁾ | I _F | 240 | mA |
| Power Dissipation | P _D | 8.7 | W |
| Pulse Forward Current ⁽²⁾ | I _{FP} | 360 | mA |
| Storage Temperature | T _{stg} | -40 ~ 100 | °C |
| Operating Temperature | T _{opr} | -40 ~ 100 | °C |
| Junction Temperature | T _J | 125 | °C |
| Assembly Temperature | - | 260 (max. 10sec) | °C |

(1) Proper current rating must be observed to maintain junction temperature below maximum at all time

(2) IFP Condition: Duty 1/10, Pulse within 10msec

Ordering Code

P C 5 5 U 1 4 0 - A 2 7 1 3 0 G P G R Y Y - 0 0 0

| | | | | | | | | | | | | | | | | | | | | | | |
|---|---|---|---|---|---|---|---|---|----|----|----|----|----|----|----|----|----|----|----|----|----|----|
| 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 | 16 | 17 | 18 | 19 | 20 | 21 | 22 | 23 |
|---|---|---|---|---|---|---|---|---|----|----|----|----|----|----|----|----|----|----|----|----|----|----|

| Item | Pos. | Code | Spec | |
|---------------------------------|--------------------|----------|--------------------|------------------|
| Model Name | 1-8 | PC55U140 | PC55U14 V0 | |
| CIE Center Point | 9 | A | ANSI 1931 on B.B.L | |
| CCT | 10,11 | 27 | 27 = 2700K | |
| | | 30 | 30 = 3000K | |
| | | 40 | 40 = 4000K | |
| | | 50 | 50 = 5000K | |
| R9 | 12 | 1 | R9 > 50 | |
| CIE Bin Group ⁽¹⁾ | 13,14 | 30 | 273 | |
| | | 50 | 273,275 | |
| IV Bin Group | 15,16, | GP,GQ | Bin code : GP,GQ | |
| | 17,18 | GQ,GR | Bin code : GQ,GR | |
| Vf Bin Group | 19,20 | YY | Bin code : Y | |
| Kitting | CIE ⁽¹⁾ | 21 | 0 | No requirements. |
| Rules | IV | 22 | 0 | No requirements. |
| | Vf | 23 | 0 | No requirements. |

(1) The first two digits 27 means CCT in 2700K, can be replaced to 30, 40, 50 for different CCT requirements.

■ **Standard Ordering Code:**

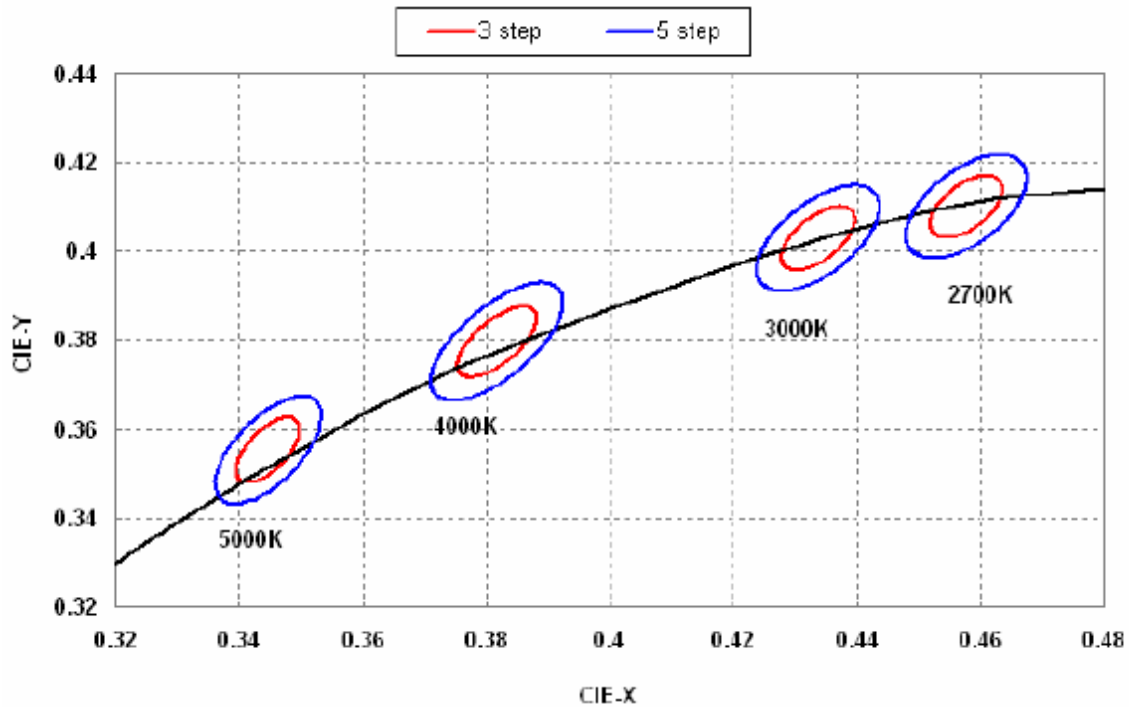
| CCT | Ordering Code ⁽¹⁾ | CIE Bin Group | IV Bin Group | Vf Bin Group |
|-------|------------------------------|------------------|-----------------|-----------------|
| 2700K | PC55U140-A27130GPGRYY-000 | 30 | GP,GQ,GR | YY |
| | PC55U140-A27150GPGRYY-000 | 50 | | |
| 3000K | PC55U140-A30130GPGRYY-000 | 30 | GP,GQ,GR | YY |
| | PC55U140-A30150GPGRYY-000 | 50 | | |
| 4000K | PC55U140-A40130GPGRYY-000 | 30 | GP,GQ,GR | YY |
| | PC55U140-A40150GPGRYY-000 | 50 | | |
| 5000K | PC55U140-A50130GPGRYY-000 | 30 | GP,GQ,GR | YY |
| | PC55U140-A50150GPGRYY-000 | 50 | | |

(1) Only under an agreement between customer and Lextar Electronics, Ordering codes not in “Standard Ordering Code Definitions” can be supplied.

Binning

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Chromaticity Coordinates(Ta=85°C)



| Items | 2700K 3-Step (273S) | 3000K 3-Step (303S) | 4000K 3-Step (403S) | 5000K 3-Step (503S) |
|------------------|------------------------|------------------------|------------------------|------------------------|
| Center Point, Cx | 0.4578 | 0.4338 | 0.3818 | 0.3447 |
| Center Point, Cy | 0.4101 | 0.4030 | 0.3797 | 0.3553 |
| Major Axis, a | 0.0081 | 0.0083 | 0.0093 | 0.0082 |
| Minor Axis, b | 0.0042 | 0.0040 | 0.0040 | 0.0035 |
| Rotation Angle | 53.7 | 53.2 | 53.7 | 59.6 |

| Items | 2700K 5-Step (275S) | 3000K 5-Step (305S) | 4000K 5-Step (405S) | 5000K 5-Step (505S) |
|------------------|------------------------|------------------------|------------------------|------------------------|
| Center Point, Cx | 0.4578 | 0.4338 | 0.3818 | 0.3447 |
| Center Point, Cy | 0.4101 | 0.4030 | 0.3797 | 0.3553 |
| Major Axis, a | 0.0135 | 0.01390 | 0.0156 | 0.0137 |
| Minor Axis, b | 0.0070 | 0.00680 | 0.0040 | 0.0059 |
| Rotation Angle | 53.7 | 53.2 | 53.7 | 59.6 |

■ **Bin code definition**

| CIE Rank | Luminous Flux Rank | V _F Rank |
|----------|--------------------|---------------------|
| 273S | GP | Y |

| V _F Rank | Condition | Min. | Max. |
|---------------------|-------------------------|------|------|
| Y | I _F = 150 mA | 32.6 | 39.8 |

| Luminous Flux Rank | Condition | Min. | Max. |
|--------------------|-------------------------|------|------|
| GP | I _F = 150 mA | 550 | 600 |
| GQ | | 600 | 660 |
| GR | | 660 | 726 |
| GS | | 726 | 799 |

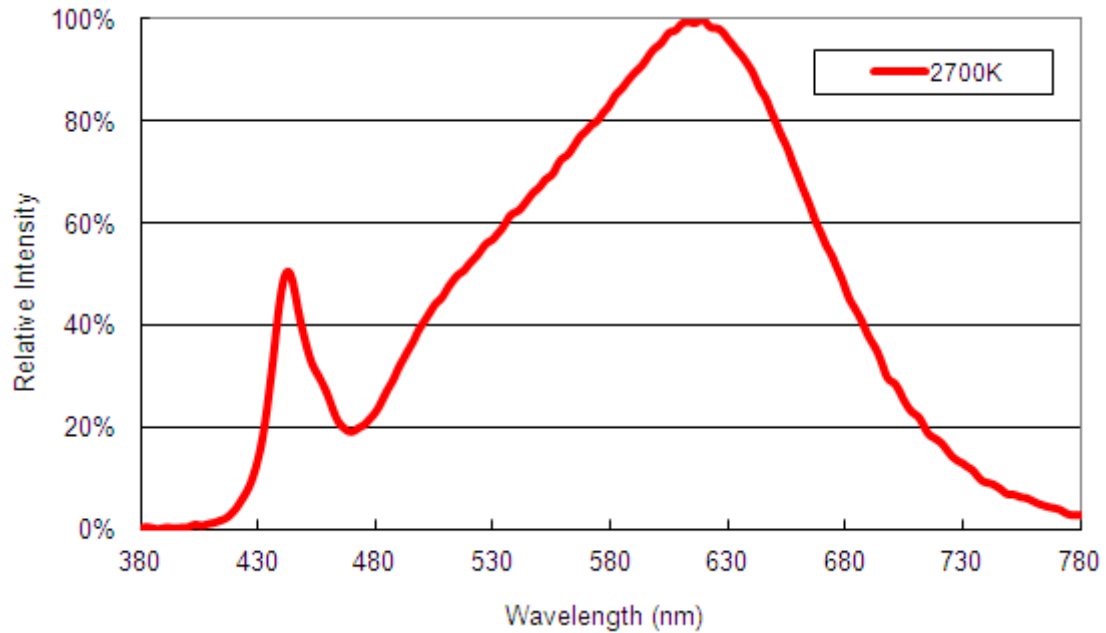
Note:

- (1) Correlated color Temperature is derived from the CIE 1931 Chromaticity diagram
- (2) CIE Measurement tolerance is ± 0.005
- (3) The luminous flux tolerance is ±7%
- (4) The Forward Voltage tolerance is ±3%

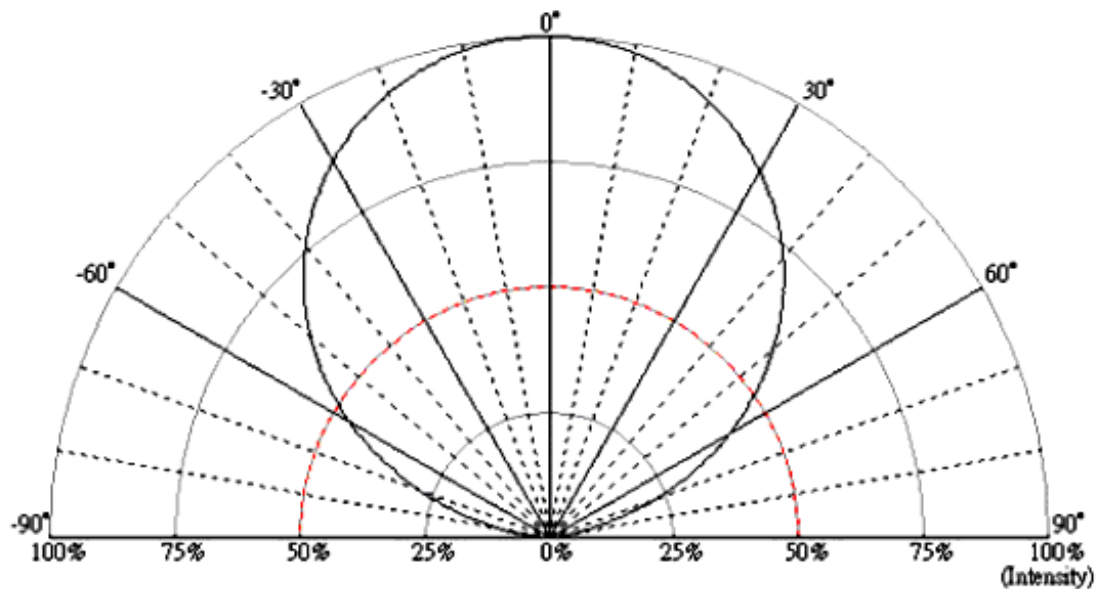
Characteristics

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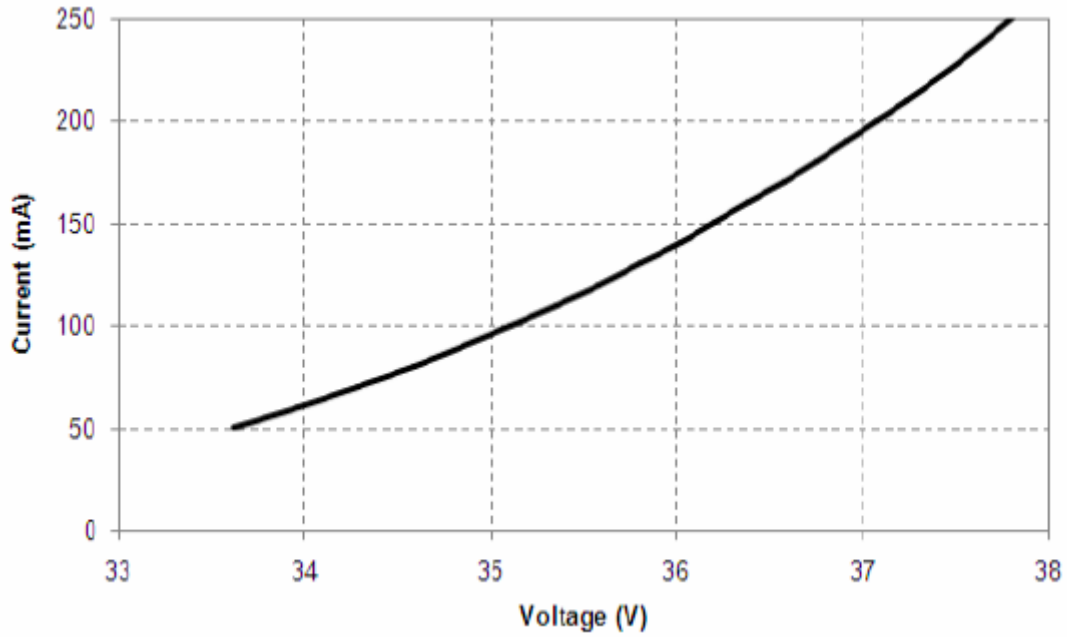
Radiation Pattern



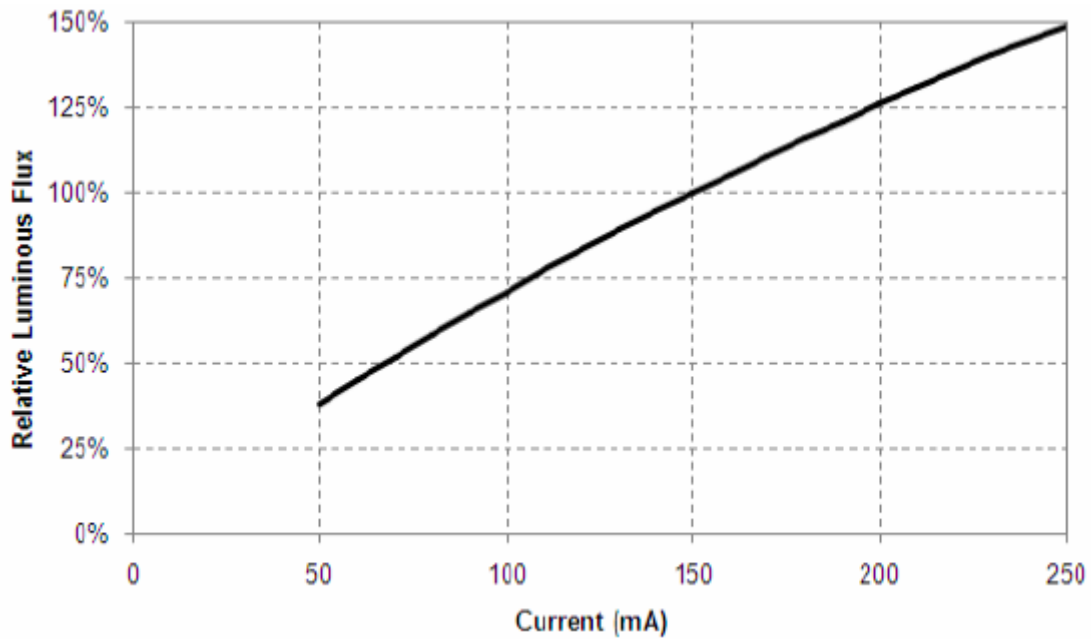
Radiation Pattern



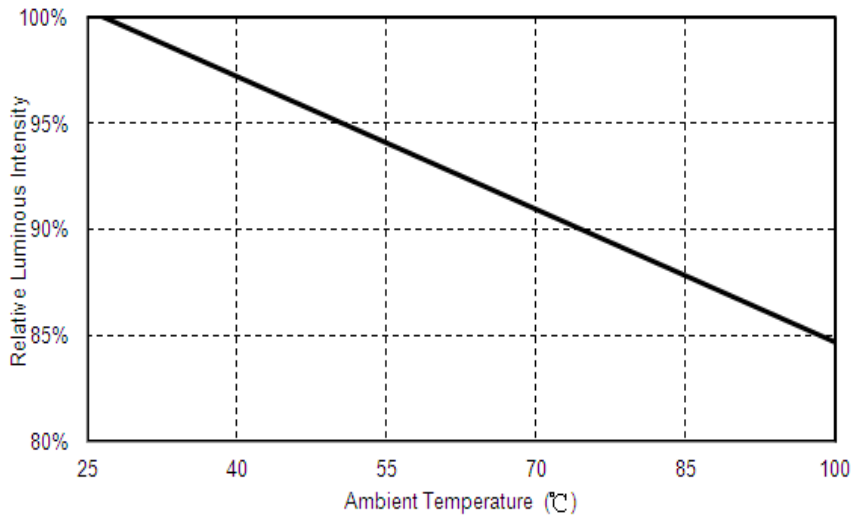
■ Forward Voltage vs. Forward Current



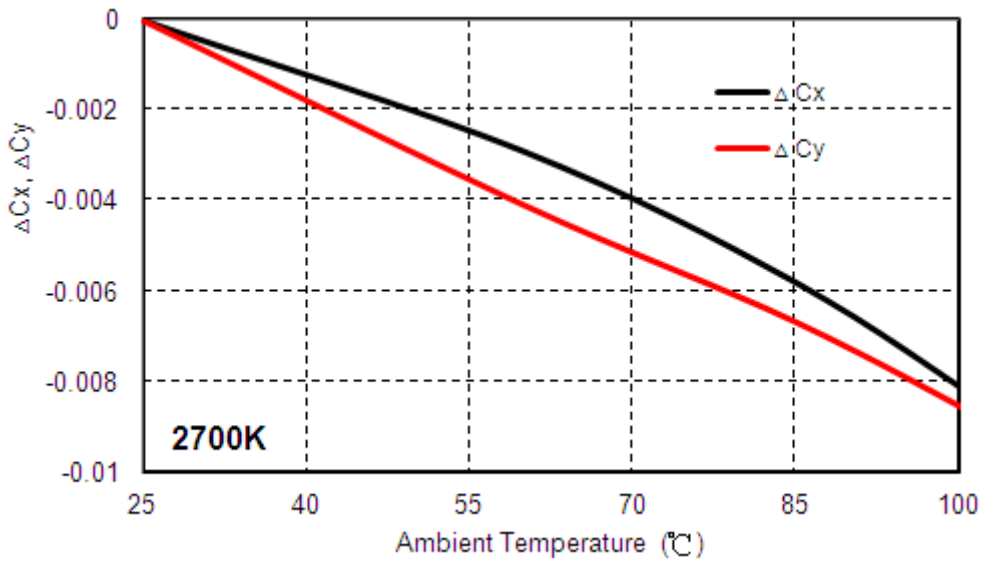
■ Forward Current vs. Relative Luminosity



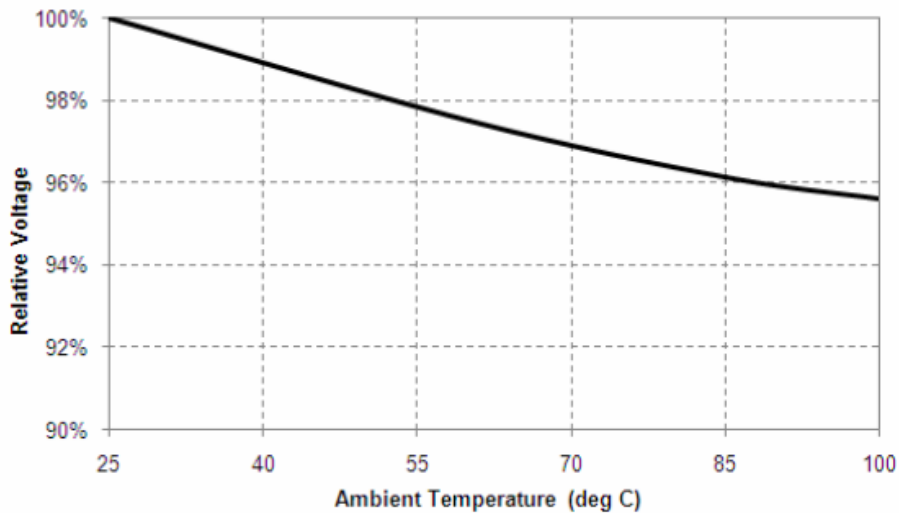
■ Relative Luminous Intensity vs. Ambient Temperature



■ Chromaticity vs. Ambient Temperature



■ Relative VF vs. Ambient Temperature



Reliability

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Reliability test

| Item | Condition | Time/Cycle |
|--|---|------------|
| Steady State Operating Life of Low Temperature -40°C | -40°C Operating | 1000 Hrs |
| Steady State Operating Life of High Temperature 60°C | 60°C Operating | 1000 Hrs |
| Steady State Operating Life of High Temperature 85°C | 85°C Operating | 1000 Hrs |
| Steady State Operating Life of High Temperature 100°C | 105°C Operating | 1000 Hrs |
| Low temperature storage -40°C | -40°C Storage | 1000 Hrs |
| High temperature storage 100°C | 105°C Storage | 1000 Hrs |
| Steady State Operating Life of High Humidity Heat 60°C 90% | 60°C/90% Operating | 1000 Hrs |
| Resistance to soldering heat on PCB (JEDEC MSL3) | pre-store@60°C, 60%RH for 52hrs Tsltd max.=260°C 10sec | 3 Times |
| Thermal shock | -40°C/20minr ~5minr ~ 100°C/20min | 300 Cycles |

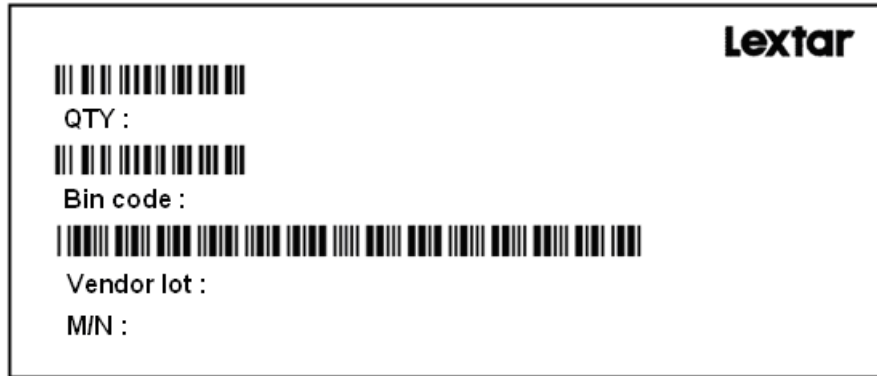
Judgment Criteria

| Item | Symbol | Test Condition | Judgment Criteria |
|-----------------|--------|----------------|---------------------|
| Forward Voltage | Vf | 150mA | $\Delta Vf < 10 \%$ |
| Luminous Flux | Iv | 150mA | $\Delta Iv < 30 \%$ |

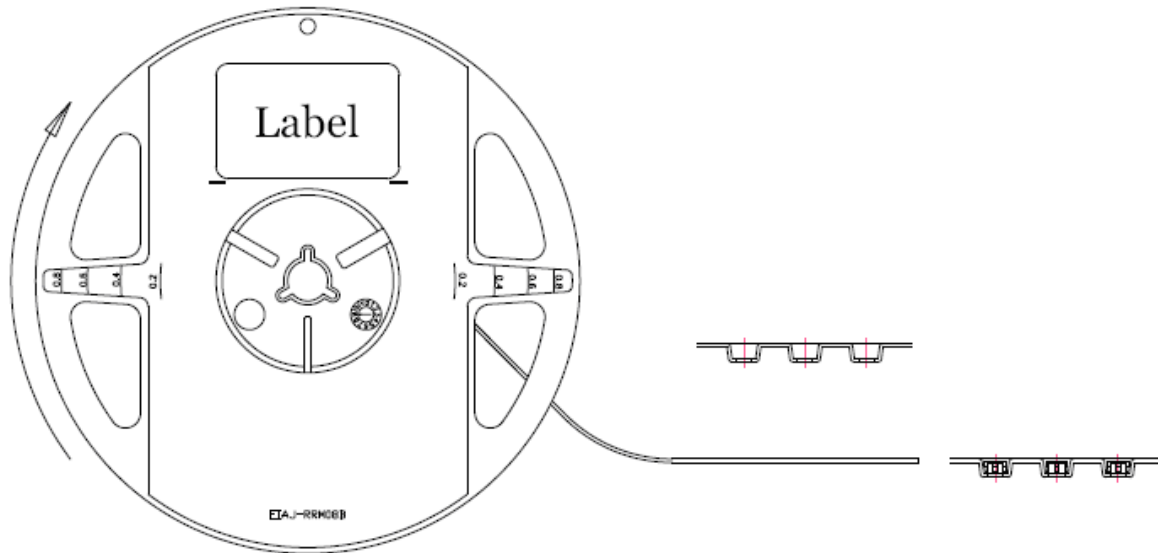
Packing

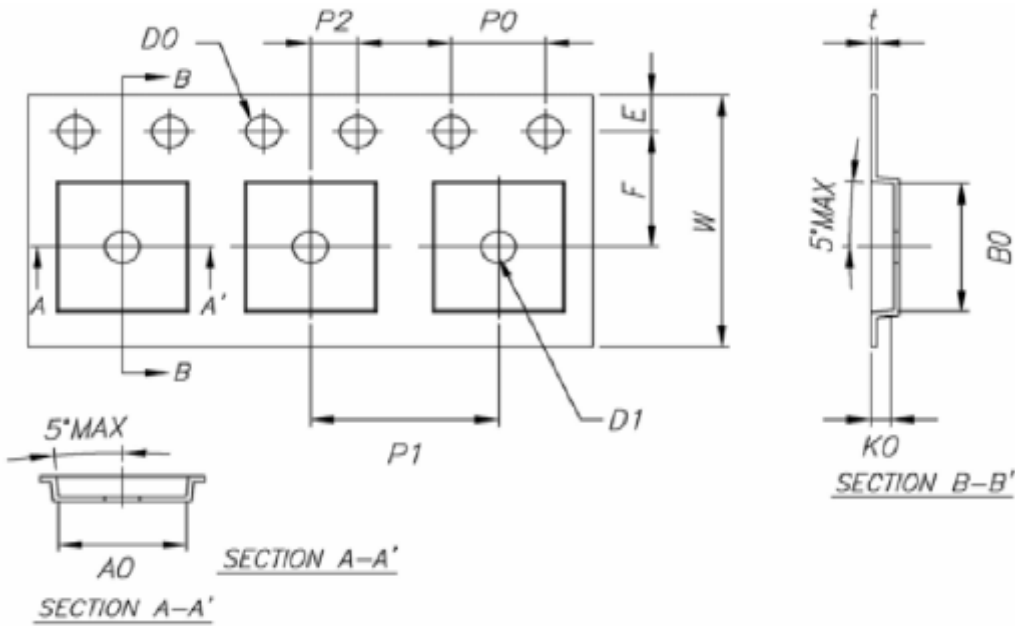
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Label



Carrier Taping



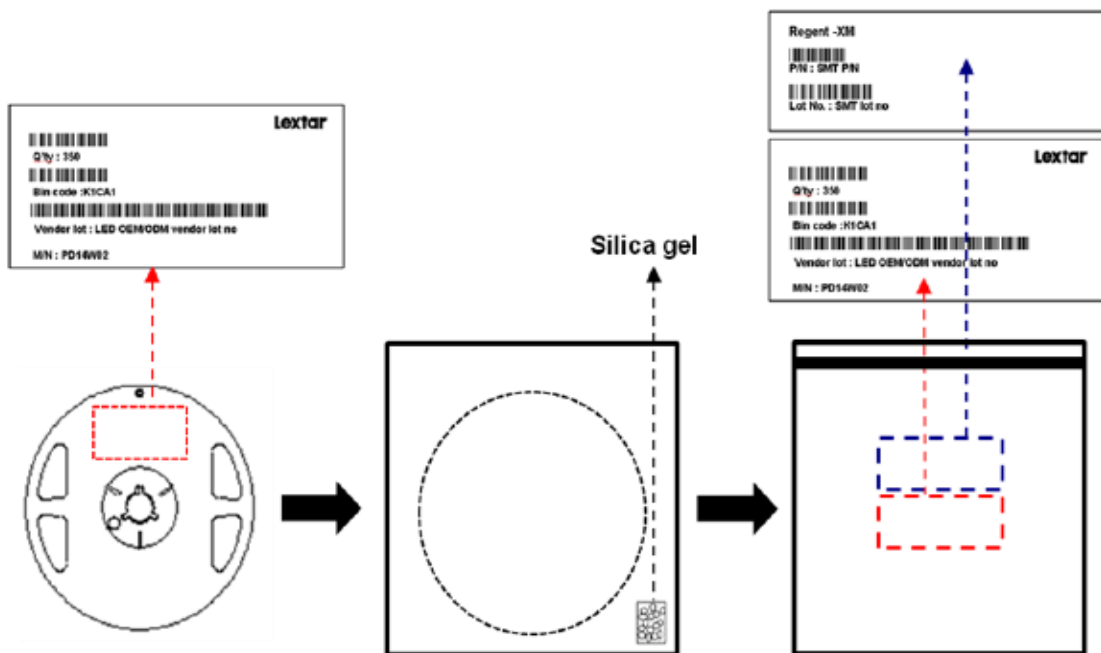


PS : unit : mm

Notice:

1. 10 Sprocket hole pitch cumulative tolerance is $\pm 0.20\text{mm}$.
2. Carrier camber shall be not more than 1mm per 100mm through a length of 250mm.
3. Ao & Bo measured on a place in the middle of the corner radii.
4. Ko measured from a place on the inside bottom of the pocket to top surface of carrier.
5. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.
6. Surface resistivity $10^4 \sim 10^8 \text{ ohm/sq}$.

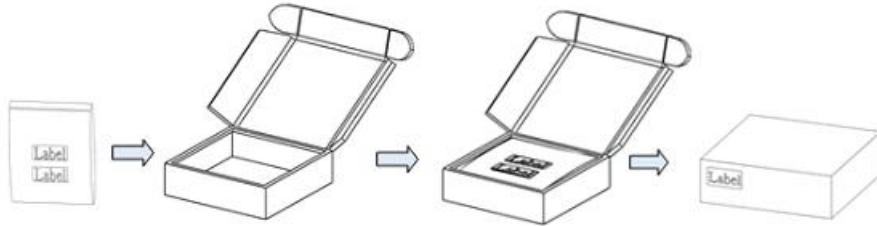
Shield Bag Taping



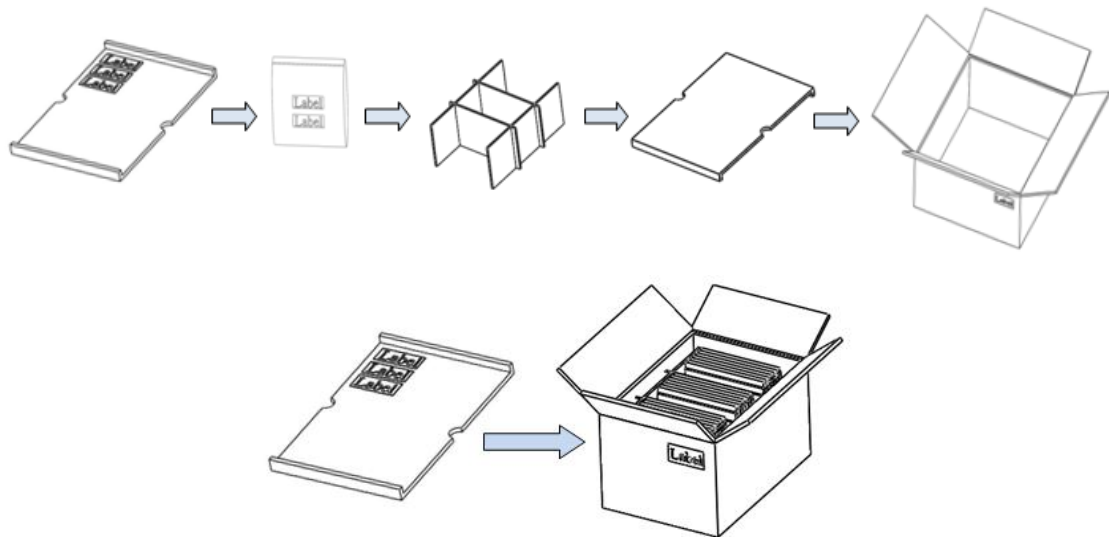
■ **Packing Box**

| Type | Large Box | | Medium Box | | Small Box | |
|---------------|---------------|------|---------------|------|--------------|-----|
| Dimension | 541X511X276mm | | 385X303X260mm | | 283X235x70mm | |
| Maximum Reels | 7"X12mm Reel | 64/R | 7"X12mm Reel | 21/R | 7"X12mm Reel | 4/R |
| Minimum Reels | 7"X12mm Reel | 32/R | 7"X12mm Reel | 9/R | 7"X12mm Reel | 1/R |

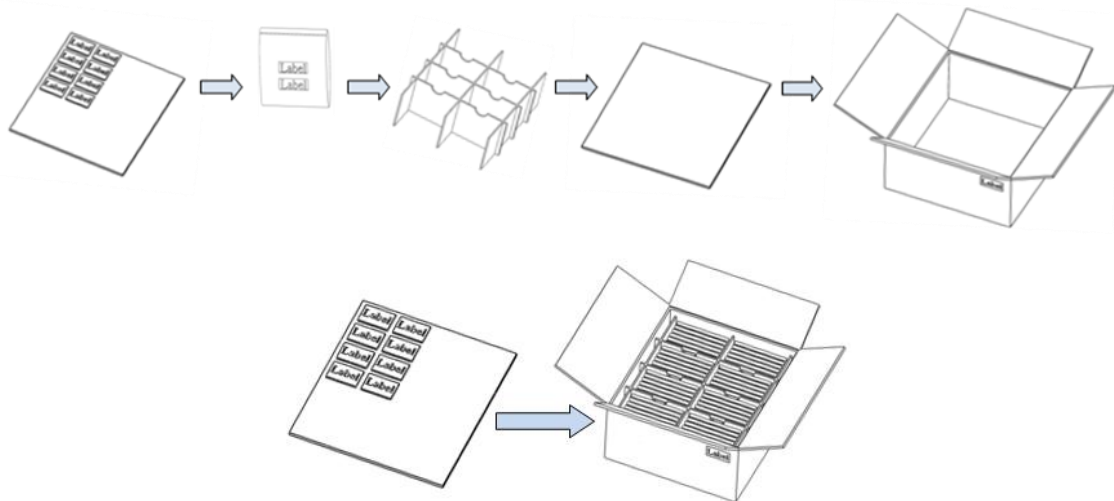
■ **Small Box**



■ **Medium Box**



■ **Large Box**



Precautions

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■ Safety Precautions

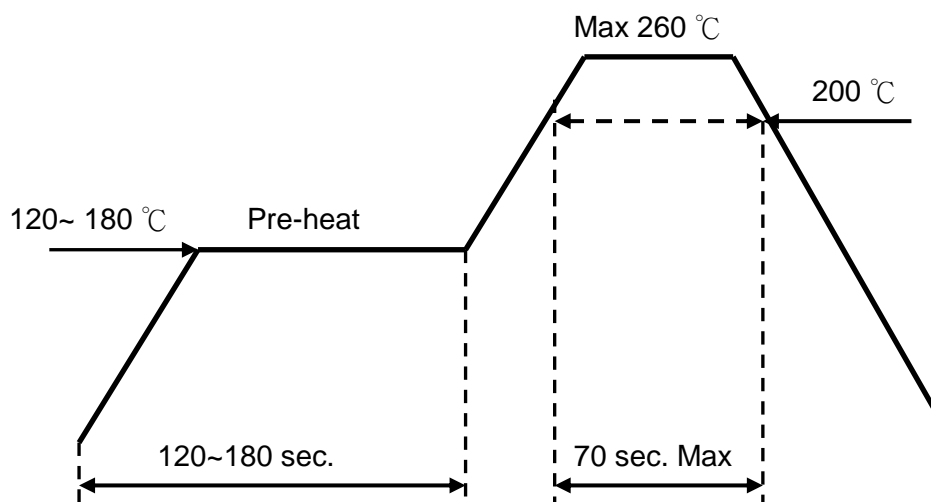
- The LED light output is too strong for human eyes without shield. Prevent eye contact directly more than seconds.
- Ensure operating under maximum rating.

■ Storage

- Before opening the package, the LEDs should storage under 30°C, 60% RH.
- After opening the package bag, the LEDs should be keep under 30°C, 60% RH. Recommend to use within 168 hrs. If unused LEDs remain, suggest to store into moisture proof bag or original package bag with moisture absorbent material such as silica gel. Reseal well is necessary.
- If the product exceeded the storage period or the moisture absorbent material faded away, baking treatment should be done by following conditions.
Bake condition: 60°C, 12hours (One time only).

■ Soldering Notice and Conditions

- When soldering LEDs,
- Do not solder/reflow the same LED over two times.
- Recommend soldering conditions:
Hand soldering: 350 °C max, 3 sec. max.
Reflow soldering: Pre-heat 150 °C max, 180 sec. max.
Peak 260 °C max, 10 sec. max.
- Reflow temperature profile as below: (lead-free solder)



- When soldering, don't put stress on the LEDs
- After LEDs have been soldered, strongly recommend not to repair to keep the LEDs performance.

■ Static Electricity

- LED package is extremely sensitive to static electricity. It's recommended that anti-electrostatic glove and wrist band is necessary when handling the LEDs. All devices are also be grounded properly as well.
- Protection devices design should be considered in the LED driving circuit.

■ Cleaning

- If washing is required, recommend to use alcohol as a solvent.
- Recommend to avoid cleaning the LEDs by ultrasonic. If necessary, pre-test the LED is necessary to confirm whether any damage occur after the process.

Revision History

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| Date | Contents | Writer | Approved |
|------------|-------------|------------|--------------|
| 2016.06.23 | New version | Kenis Hung | Berris Huang |

Smart Lighting Amazing Life

Lextar Electronics Corp. is the leading LED (Light Emitting Diode) maker integrating upper stream epitaxial, middle stream chip, and downstream package, SMT and LED lighting applications. Founded in May, 2008, Lextar is a subsidiary of AU Optronics, the leading TFT-LCD and solar PV manufacturer. Lextar's product applications include lighting and LCD backlight. Lextar's manufacturing sites include Hsinchu and Chunan in Taiwan, and Suzhou in China. The company turnover in 2010 is 266 million USD.

单击下面可查看定价，库存，交付和生命周期等信息

[>>Lextar\(隆达\)](#)